



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Group Art Unit: 2814

Examiner: MAI, ANH D

In re PATENT APPLICATION of:

Applicants : Hiroki NAKAMURA)

Appl. No. : 09/625,178)

Filed : July 25, 2000)

For : SEMICONDUCTOR DEVICE)
HAVING WIRING PATTERNS)
AND DUMMY PATTERNS COVERED)
WITH INSULATING LAYER)

Attorney Ref.: F98ED0762)

**INFORMATION
DISCLOSURE
STATEMENT**

September 8, 2003

Commissioner of Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This is an Information Disclosure Statement submitted in compliance with the timing requirements of 37 C.F.R. § 1.97(c)(1).

Attached are copies of (1) one Office Action from Japanese Patent and Trademark Office and its English translation, (2) two Japanese laid open patent publications and their English translations, (3) one US patent publication, which is a counterpart of one Japanese laid open patent publication mentioned above. The publications are listed on the attached Form PTO-1449.

Each item of information contained in the information disclosure statement was first cited in any communication from Japanese patent Office in a counterpart Japanese application not more than three months prior to the filing of this information disclosure statement. Since this Information Disclosure Statement is being filed based on 37 C.F.R. § 1.97(c)(1) with a above-mentioned statement specified paragraph (e)(1), no fee is required, and the requirements of 37 C.F.R. §§ 1.97 and 1.98 are deemed to be fully met as to all documents submitted. Consideration of the submitted documents is respectfully requested.

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Respectfully submitted,

A handwritten signature in black ink, appearing to read 'Junichi Mimura', written over a horizontal line.

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September 8, 2003



FORM PTO-1449 INFORMATION DISCLOSURE STATEMENT				Atty Docket F98ED0762		U.S. Application No.: 09/625,178	
				Applicant Hiroki Nakamura			
				U.S. Filing Date July 25, 2000		Group 2814	
U.S. PATENT DOCUMENTS							
Examiner Initial		Document Number	Date	Name	Class	Sub-Class	Filing Date
	AA	5,808,363	09/15/98	Watanabe	257	758	11/14/96
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
FOREIGN PATENT DOCUMENTS							
		Document Number	Date	Country	Class	Sub-Class	Translation
	AL	Japanese Laid open patent 07-161706 ✓	6/23/95	JAPAN	H01L	21/316	Full translation
	AM	Japanese Laid open patent 09-139431 ✓	5/27/97	JAPAN	H01L	21/382	Full translation
	AN						
	AO						
OTHER (Including Author, Title, Date, Pertinent Pages, etc.)							
	AR						
	AS						
Examiner					Date Considered		
EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.							

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